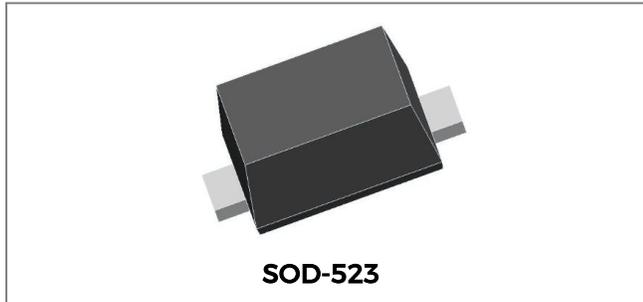


CESD3V3D5 THRU CESD24VD5 ESD Protection Diodes



Description

The CESD3V3D5 THRU CESD24VD5 is designed to protect voltage sensitive components from ESD. Excellent clamping capability, low leakage, and fast response time provide best in class protection on designs that are exposed to ESD. Because of its small size, it is suited for use in cellular phones, MP3 players, digital cameras and many other portable applications where board space is at a premium.

Schematic & Pin Configuration



Mechanical Data

- Stand-off Voltage: 3.3 V-24V
- Low Leakage
- Response Time is Typically < 1 ns
- ESD Rating of Class 3B per Human Body Model
- IEC61000-4-2 Level 4 ESD Protection
- These are Pb-Free Devices

Maximum Ratings @T_A=25°C unless otherwise specified

Parameter	Symbol	Value	Units
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V _{ESD}	±25 ±25	kV
Peak Pulse Power (Note 1)	P _{PP}	210(CESD3V3D5) 170(CESD5V0D5) 170(CESD12VD5) 175(CESD15VD5) 190(CESD24VD5)	W
Thermal Resistance Junction-to-Ambient	R _{θJA}	833	°C/W
Lead Solder Temperature - Maximum (10 Second Duration)	T _L	260	°C
Operating Junction Temperature Range	T _J	-40 to +125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Note1. Non-repetitive current pulse 8/20µs exponential decay waveform according to IEC61000-4-5.

Electrical Characteristics@25°C

Symbol	Parameter
I_{PP}	Maximum Reverse Peak Pulse Current At 8/20 μ s Waveform
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Working Peak Reverse Voltage
I_R	Maximum Reverse Leakage Current @ V_{RWM} , Pulse width < 300 μ s, duty cycle < 2%
V_{BR}	Breakdown Voltage @ I_T , Pulse width < 300 μ s, duty cycle < 2%
I_T	Test Current
C	Max. Capacitance @ $V_R=0$ and $f=1$ MHz

Device	Device Marking	V_{RWM} (V)	$I_R(\mu A)$ @ V_{RWM}	V_{BR} (V) @ I_T	I_T	I_{pp} (A)	$V_C(V)$ @ Max I_{pp}	C(pF)
		Max.	Max.	Min.	mA	Max.	Max.	Typ.
CESD3V3D5	ZE	3.3	100	4.0	1.0	16	13	120
CESD5V0D5	ZF	5.0	10	6.2	1.0	13	13	160
CESD12VD5	ZM	12	1	13.3	1.0	6	28	45
CESD15VD5	ZP	15	1	16.7	1.0	5	35	48
CESD24VD5	ZY	24	1	26.7	1.0	4	48	36

Note: V_{BR} is measured with a pulse test current I_T at an ambient temperature of 25°C.

Ratings and Characteristics Curves

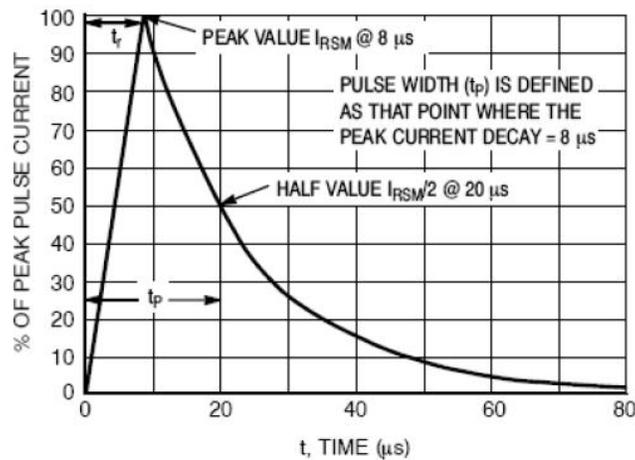


Figure 1. 8 x 20 μ s Pulse Waveform

Ordering Information

Device	Package	Shipping
CESD Series	SOD-523 (Pb-Free)	8000pcs / reel

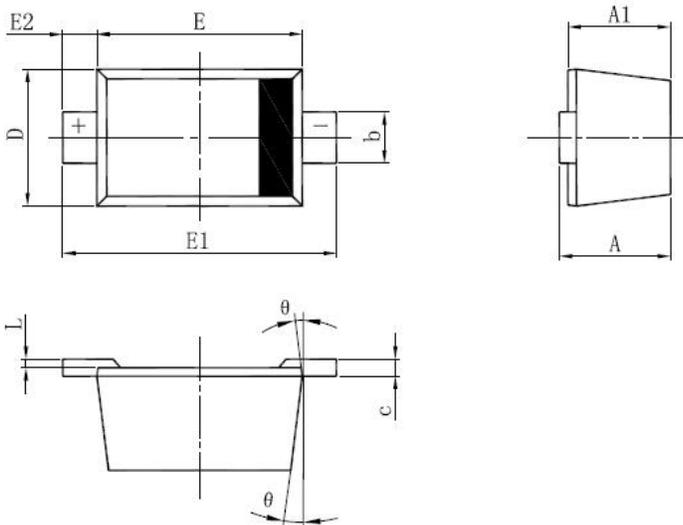
For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram



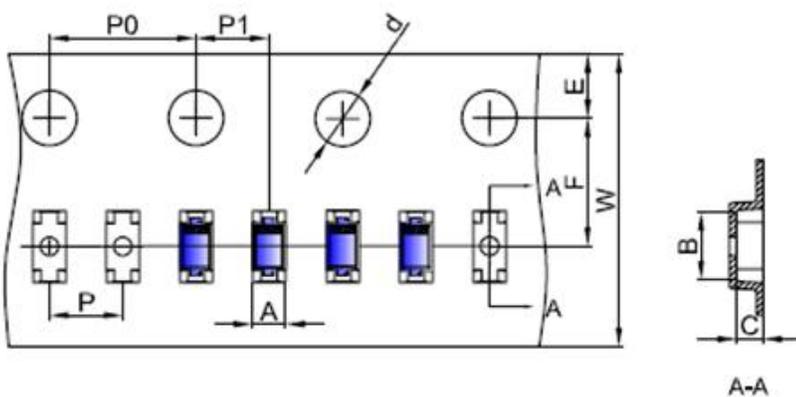
ZF = Device Marking

Mechanical Dimensions SOD-523



SYMBOL	Millimeters		Inches	
	MIN.	MAX.	MIN.	MAX.
A	0.510	0.770	0.020	0.031
A1	0.500	0.700	0.020	0.028
b	0.250	0.350	0.010	0.014
c	0.080	0.150	0.003	0.006
D	0.750	0.850	0.030	0.033
E	1.100	1.300	0.043	0.051
E1	1.500	1.700	0.059	0.067
E2	0.200REF		0.08REF	
L	0.010	0.070	0.001	0.003
θ	7°REF		7°REF	

Carrier Tape Specification SOD-523



SYMBOL	Millimeters	
	Min.	Max.
A	0.85	0.95
B	1.89	1.99
C	0.68	0.78
d	1.40	1.60
E	1.65	1.85
F	3.40	3.60
P	1.90	2.10
P0	3.90	4.10
P1	1.90	2.10
W	7.90	8.30

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